

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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3A, 50V - 600V Surface Mount Super Fast Rectifier

FEATURES

- Glass passivated chip junction
- Ideal for automated placement
- Super fast recovery time for high efficiency
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

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- High frequency rectification
- Freewheeling application
- Switching mode converters and inverters in computer, automotive and telecommunication.

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- Case: DO-214AB (SMC)
- Molding compound meets UL 94V-0 flammability rating
- Part no. with suffix "H" means AEC-Q101 qualified
- Packing code with suffix "G" means green compound (halogen-free)
- Moisture sensitivity level: level 1, per J-STD-020
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 0.21 g (approximately)

KEY PARAMETERS							
PARAMETER	VALUE	UNIT					
$I_{F(AV)}$	3	Α					
V_{RRM}	50 - 600	V					
I _{FSM}	100	Α					
T_{JMAX}	150	°C					
Package	DO-214AB (SMC)						
Configuration	Single die						





DO-214AB (SMC)

PARAMETER	SYMBOL	ES3A	ES3B	ES3C	ES3D	ES3F	ES3G	ES3H	ES3J	UNIT
Marking code on the device		ES3A	ES3B	ES3C	ES3D	ES3F	ES3G	ES3H	ES3J	
Repetitive peak reverse voltage	V_{RRM}	50	100	150	200	300	400	500	600	V
Reverse voltage, total rms value	$V_{R(RMS)}$	35	70	105	140	210	280	350	420	V
Maximum DC blocking voltage	V _{DC}	50	100	150	200	300	400	500	600	V
Forward current	I _{F(AV)}				3	3				Α
Surge peak forward current, 8.3 ms single half sine-wave superimposed on rated load per diode	I _{FSM}	100					Α			
Junction temperature	TJ	- 55 to +150				°C				
Storage temperature	T _{STG}				- 55 tc	+150				°C

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THERMAL PERFORMANCE							
PARAMETER	SYMBOL	LIMIT	UNIT				
Junction-to-lead thermal resistance per diode	$R_{\Theta JL}$	12	°C/W				
Junction-to-ambient thermal resistance per diode	$R_{\Theta JA}$	47	°C/W				

PARAMETER		CONDITIONS	SYMBOL	TYP.	MAX.	UNIT
Forward voltage per diode (1)	ES3A ES3B ES3C ES3D	I _F = 3A, T _J = 25°C	V _F	1	0.95	V
Forward voltage per diode	ES3F ES3G	IF = 3A, IJ = 23 C	VF	-	1.30	V
	ES3H ES3J			-	1.70	V
		T _J = 25°C		-	10	μΑ
Reverse current @ rated V _R per	diode	T _J = 100°C	- I _R	-	500	μΑ
lunction consoltance	ES3A ES3B ES3C ES3D	1 MU= V 4 0V	6	45	-	pF
Junction capacitance	ES3F ES3G ES3H ES3J		CJ	30	-	pF
Reverse recovery time		I _F =0.5A , I _R =1.0A I _{RR} =0.25A	t _{rr}	-	35	ns

Notes:

- 1. Pulse test with PW=0.3 ms
- 2. Pulse test with PW=30 ms



ORDERING INFORMATION								
PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	PACKAGE	PACKING			
		R7		SMC	850 / 7" Plastic reel			
	Н	R6	G	SMC	3,000 / 13" Paper reel			
ES3x (Note 1)		M6		SMC	3,000 / 13" Plastic reel			
(Note 1)		V7		Matrix SMC	850 / 7" Plastic reel			
		V6		Matrix SMC	3,000 / 13" Plastic reel			

Note:

^{1. &}quot;x" defines voltage from 50V (ES3A) to 600V (ES3J)

EXAMPLE							
EXAMPLE P/N	PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION		
ES3AHR7G	ES3A	Н	R7	G	AEC-Q101 qualified Green compound		

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CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig.1 Forward Current Derating Curve

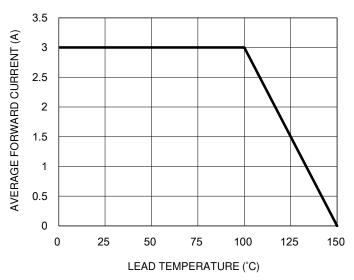


Fig.2 Typical Junction Capacitance

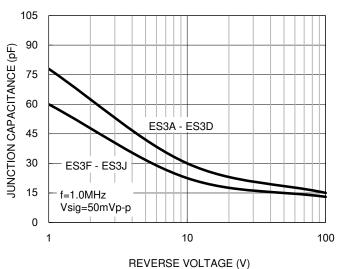


Fig.3 Typical Reverse Characteristics

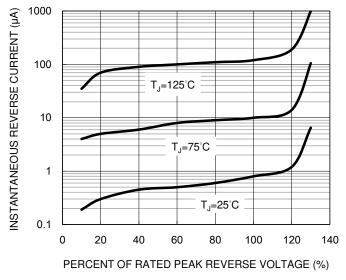
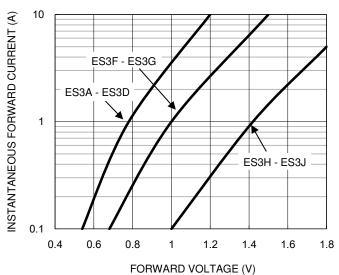


Fig.4 Typical Forward Characteristics





CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig.5 Maximum Non-repetitive Forward Surge Current

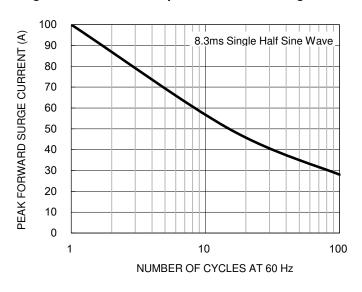


Fig.6 Typical Transient Thermal Characteristics

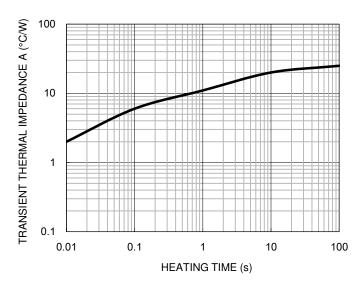
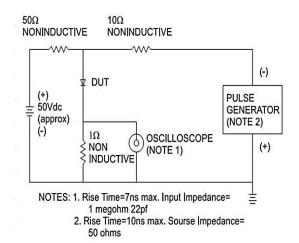
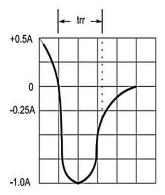


Fig.7 Reverse Recovery Time Characteristic And Test Circuit Diagram

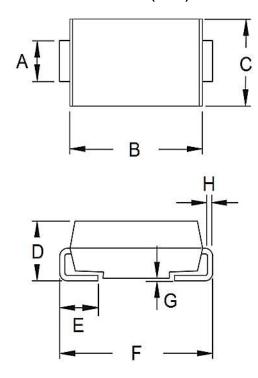






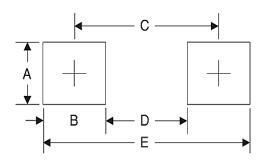
PACKAGE OUTLINE DIMENSIONS

DO-214AB (SMC)



DIM.	Unit	(mm)	Unit (inch)		
DIW.	Min.	Max.	Min.	Max.	
Α	2.90	3.20	0.114	0.126	
В	6.60	7.11	0.260	0.280	
С	5.59	6.22	0.220	0.245	
D	2.00	2.62	0.079	0.103	
E	1.00	1.60	0.039	0.063	
F	7.75	8.13	0.305	0.320	
G	0.10	0.20	0.004	0.008	
Н	0.15	0.31	0.006	0.012	

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
А	3.30	0.130
В	2.50	0.098
С	6.80	0.268
D	4.40	0.173
E	9.40	0.370

MARKING DIAGRAM



P/N =Marking Code

G =Green Compound

YW =Date Code F =Factory Code



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